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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT		
Static								
Drain-source breakdown voltage	V	V 0.V I 250A	Ch-1	30	-	-	\/	
	V_{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	Ch-2	30	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$		Ch-1	-	33	-	- mV/°C	
		I _D = 250 μA	Ch-2	-	33	-		
Vtomporature coefficient	$\Delta V_{GS(th)}/T_{J}$	ι _D = 230 μΑ	Ch-1	-	-5	-		
V _{GS(th)} temperature coefficient			Ch-2	-	-4.6	-		
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	Ch-1	1	-	2.2	V	
		VDS - VGS, ID - 200 μΛ	Ch-2	1	-	2.2		
Gate-source leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = +20 \text{ V}$	Ch-1	-	-	± 100	nA	
		VDS = 0 V, VGS = 120 V	Ch-2	-	-	± 100		
Zero gate voltage drain current		$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$	Ch-1	-	-	1	- μΑ	
	I _{DSS}	V _{DS} = 30 V, V _{GS} = 0 V	Ch-2	-	=	1		
zero gate voltage drain current	ibss	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 \text{ °C}$	Ch-1	-	-	5		
		VDS = 30 V, VGS = 0 V, 1J = 33 C	Ch-2	-	-	5		
On-state drain current ^b	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	Ch-1	20	-	-	А	
On-state drain current			Ch-2	20	-	-		
	R _{DS(on)}	V _{GS} = 10 V, I _D = 13.8 A	Ch-1	-	0.0100	0.0120	Ω	
Drain-source on-state resistance b		$V_{GS} = 10 \text{ V}, I_D = 20 \text{ A}$	Ch-2	-	0.0053	0.0064		
		$V_{GS} = 4.5 \text{ V}, I_D = 12.6 \text{ A}$	Ch-1	-	0.0120	0.0145		
		$V_{GS} = 4.5 \text{ V}, I_D = 20 \text{ A}$	Ch-2	-	0.0068	0.0083		
Farmered transport and transport	_	V _{DS} = 10 V, I _D = 13.8 A	Ch-1	-	47	-		
Forward transconductance b	9 _{fs}	V _{DS} = 10 V, I _D = 20 A		-	63	-	S	
Dynamic ^a								
Input capacitance	C _{iss}	Observal 4	Ch-1	-	790	-	pF	
		Channel-1 $V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	Ch-2	-	2600	-		
Output capacitance	C _{oss}	103 10 1, 103 1 1, 1 1111	Ch-1	-	190	-		
Output capacitance		Channel O	Ch-2	-	485	-		
Reverse transfer capacitance	C _{rss}	Channel-2 $V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	Ch-1	-	76	-		
			Ch-2	-	215	-		
Total gate charge	Qg	$V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 13.8 \text{ A}$	Ch-1	-	14	21	nC	
		$V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 20 \text{ A}$	Ch-2	-	43	65		
		$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 13.8 \text{ A}$	Ch-1	-	6.8	11		
		$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 20 \text{ A}$	Ch-2	-	21	32		
Gate-source charge	Q_{gs}	Channel-1	Ch-1	-	2.6	-	nC	
		$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 13.8 \text{ A}$	Ch-2	-	8.1	-		
Gate-drain charge	Q _{gd}	Channel-2	Ch-1	-	1.9	-	1	
		$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 20 \text{ A}$	Ch-2	-	6.5	-]	
	R _g		Ch-1	0.4	2	-	_	
Gate resistance		f = 1 MHz	Ch-2	0.3	1.5	-	Ω	



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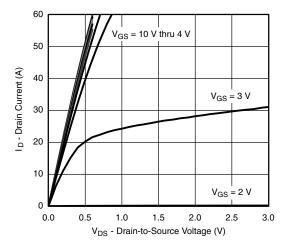
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Dynamic ^a							
Turn-on delay time	+		Ch-1	1	15	30	
Turn-on delay time	t _{d(on)}	Channel-1 $V_{DD} = 15 \text{ V}, R_{L} = 1.5 \Omega,$	Ch-2	1	23	50	ns
Rise time	t _r	$V_{DD} = 13 \text{ V, } R_L = 1.3 \Omega,$ $I_D \cong 10 \text{ A, } V_{GEN} = 4.5 \text{ V, } R_a = 1 \Omega$	Ch-1	-	12	20	
THISC LITTE		D ALIV y g	Ch-2	-	20	40	
Turn-off delay time	t _{d(off)}	Channel-2	Ch-1	-	20	40	
		$V_{DD} = 15 \text{ V}, R_L = 1.5 \Omega,$	Ch-2	-	35	70	
Fall time	t _f	$I_D\cong 10$ A, $V_{GEN}=4.5$ V, $R_g=1~\Omega$	Ch-1	-	10	20	
	-1		Ch-2	-	10	20	
Turn-on delay time	t _{d(on)}		Ch-1	-	10	20	
		Channel-1 $V_{DD} = 15 \text{ V}, R_{L} = 1.5 \Omega,$	Ch-2	-	22	25	
Rise time	t _r	$I_D \cong 10 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$	Ch-1	-	12	20	
			Ch-2	-	10	20	
Turn-off delay time	t _{d(off)}	Channel-2	Ch-1	-	20	40	-
	t _f	$V_{DD} = 15 \text{ V}, R_L = 1.5 \Omega,$	Ch-2	-	35	70	
Fall time		$I_D \cong 10 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$	Ch-1	-	10	20	
Drain-Source Body Diode Characteris	etice		Cri-2	-	10	20	
Drain-Source Body Diode Characteris			Ch-1	_		16	I
Continuous source-drain diode current	I _S	$T_C = 25 ^{\circ}C$	Ch-2	_	_	16	- - A
	I _{SM}		Ch-1	_	_	50	
Pulse diode forward current ^a			Ch-2	_	_	80	
Body diode voltage	V _{SD}		Ch-1	-	0.85	1.2	- V
		$I_{S} = 10 \text{ A}, V_{GS} = 0 \text{ V}$	Ch-2	-	0.8	1.2	
Body diode reverse recovery time	t _{rr}		Ch-1	-	20	40	ns
		Channel-1	Ch-2	-	25	50	
Body diode reverse recovery charge	Q _{rr}	$I_F = 10 \text{ A, di/dt} = 100 \text{ A/}\mu\text{s,}$ $T_{,l} = 25 \text{ °C}$		-	10	20	C
		11 = 23 0	Ch-2	-	13	25	nC
Reverse recovery fall time	t _a	Ohanad O	Ch-1	-	11	-	- ns
		Channel-2 $I_F = 10 \text{ A, di/dt} = 100 \text{ A/}\mu\text{s,}$	Ch-2	-	12	-	
Reverse recovery rise time	t _b	$T_{J} = 25 ^{\circ}\text{C}$	Ch-1	-	9	-	
			Ch-2	-	13	-	

Notes

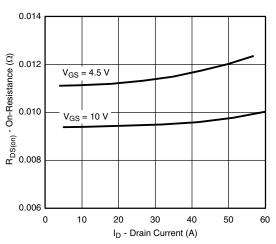
- a. Guaranteed by design, not subject to production testing
- b. Pulse test; pulse width $\leq 300~\mu s,~duty~cycle \leq 2~\%$

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

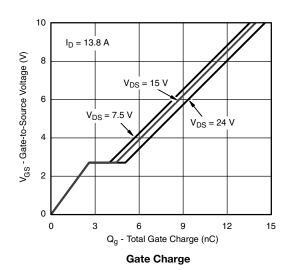


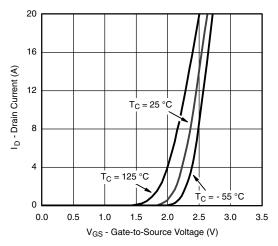


Output Characteristics

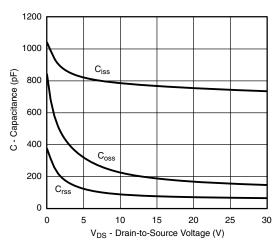


On-Resistance vs. Drain Current

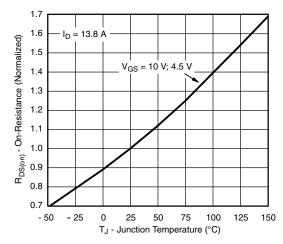




Transfer Characteristics

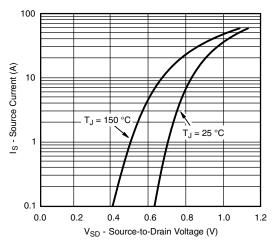


Capacitance

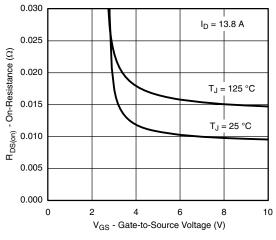


On-Resistance vs. Junction Temperature

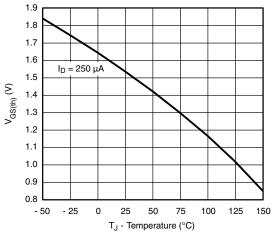




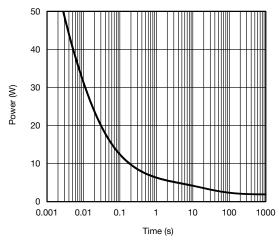
Source-Drain Diode Forward Voltage



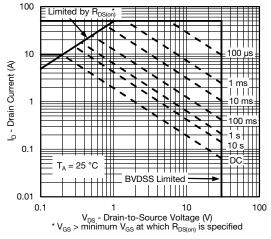
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



Single Pulse Power



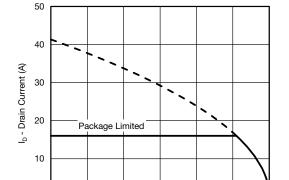
Safe Operating Area, Junction-to-Ambient

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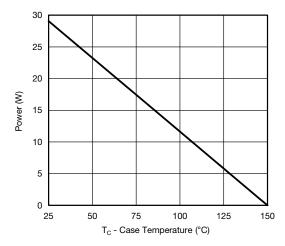
CHANNEL-1 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

150





100



Power, Junction-to-Case

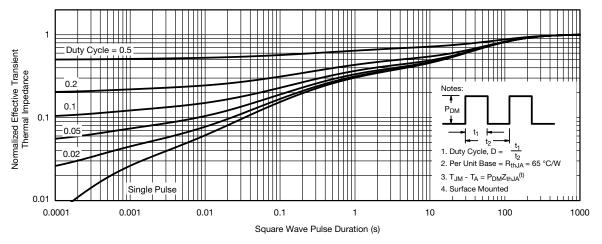
Note

0

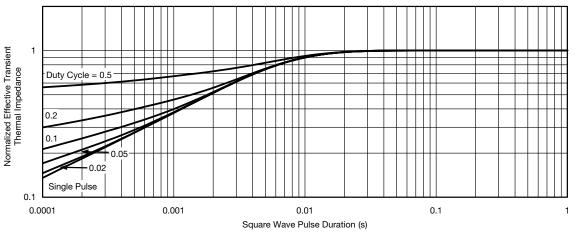
25

a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit



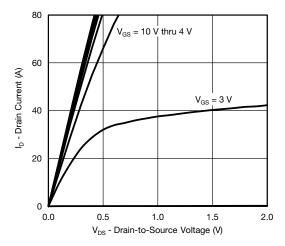


Normalized Thermal Transient Impedance, Junction-to-Ambient

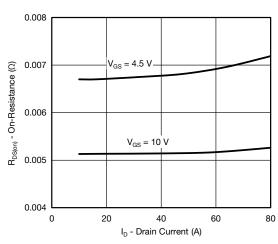


Normalized Thermal Transient Impedance, Junction-to-Case

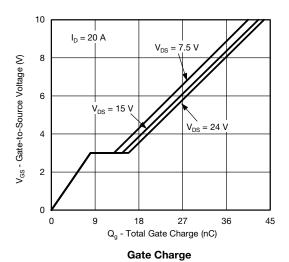


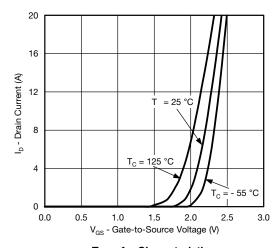


Output Characteristics

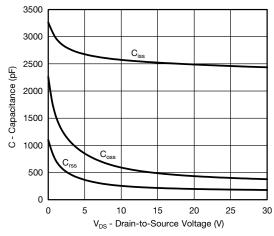


On-Resistance vs. Drain Current

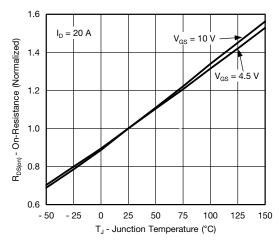




Transfer Characteristics

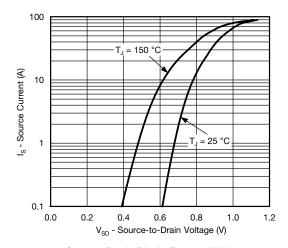


Capacitance

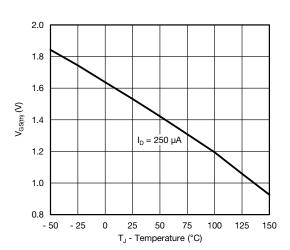


On-Resistance vs. Junction Temperature

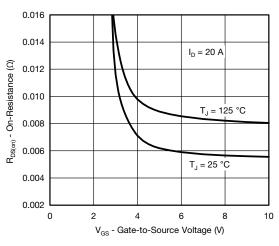




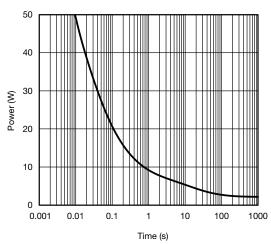
Source-Drain Diode Forward Voltage



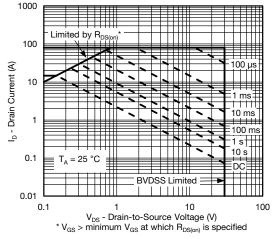
Threshold Voltage



On-Resistance vs. Gate-to-Source Voltage

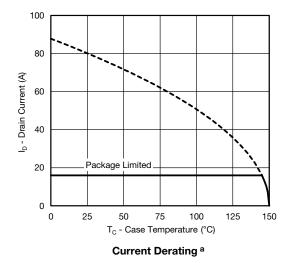


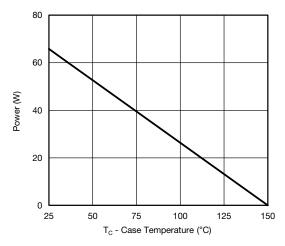
Single Pulse Power



Safe Operating Area, Junction-to-Ambient





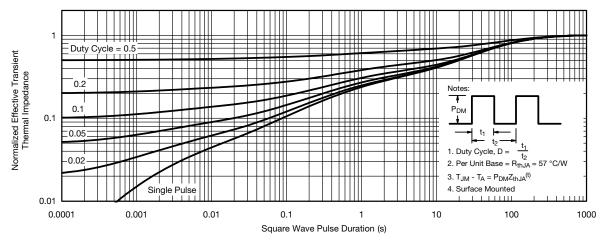


Power, Junction-to-Case

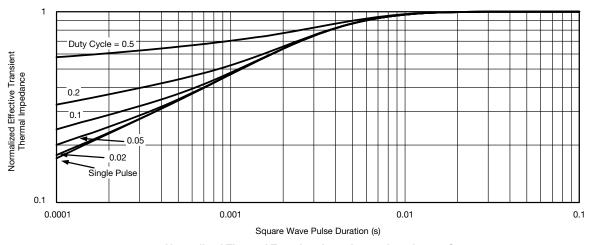
Note

a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit





Normalized Thermal Transient Impedance, Junction-to-Ambient

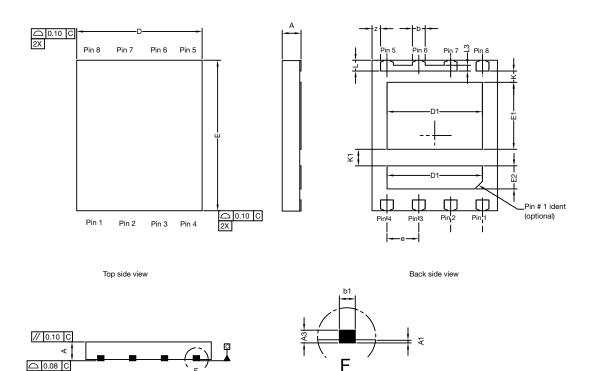


Normalized Thermal Transient Impedance, Junction-to-Case

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PowerPAIR® 6 x 5 Case Outline

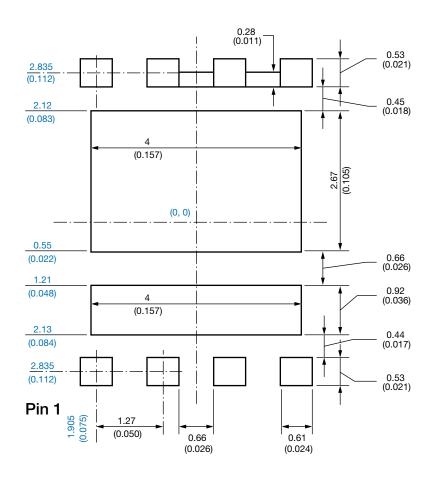


DIM.		MILLIMETERS		INCHES			
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
А	0.70	0.75	0.80	0.028	0.030	0.032	
A1	0.00	-	0.10	0.000	-	0.004	
A3	0.15	0.20	0.25	0.006	0.007	0.009	
b	0.43	0.51	0.61	0.017	0.020	0.024	
b1	0.25 BSC			0.010 BSC			
D	4.90	5.00	5.10	0.192	0.196	0.200	
D1	3.75	3.80	3.85	0.148	0.150	0.152	
Е	5.90	6.00	6.10	0.232	0.236	0.240	
E1 Option AA (for W/B)	2.62	2.67	2.72	0.103	0.105	0.107	
E1 Option AB (for BWL)	2.42	2.47	2.52	0.095	0.097	0.099	
E2	0.87	0.92	0.97	0.034	0.036	0.038	
е	1.27 BSC			0.050 BSC			
K Option AA (for W/B)	0.45 typ.			0.018 typ.			
K Option AB (for BWL)	0.65 typ.			0.025 typ.			
K1	0.66 typ.			0.025 typ.			
L	0.33	0.43	0.53	0.013	0.017	0.020	
L3	0.23 BSC			0.009 BSC			
Z	0.34 BSC			0.013 BSC			

Revision: 22-Dec-14 1 Document Number: 63656



Recommended Minimum PAD for PowerPAIR® 6 x 5



Dimensions in millimeters (inch)

Note

• Linear dimensions are in black, the same information is provided in ordinate dimensions which are in blue.

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